



Product Change Notification - LIAL-21URFI599

Date:

24 May 2018

Product Category:

Digital Potentiometers; Capacitive Touch Sensors; 8-bit PIC Microcontrollers; 16-Bit - Microcontrollers and Digital Signal Controllers; 32-bit PIC Microcontrollers; Sensor Fusion Hub; USB Power Delivery; Ethernet Controllers; Hybrid Controllers; Others; Touch Controllers; USB Bridge; Interface- Serial Peripherals; Energy Measurement

Affected CPNs:**Notification subject:**

CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

Notification text:**PCN Status:**

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

Pre Change:

Assembled at MTAI assembly site

Post Change:

Assembled at MTAI or MMT assembly site

Pre and Post Change Summary:

	Pre Change	Post Change	
Assembly Site	Microchip Technology Thailand HQ (MTAI)	Microchip Technology Thailand HQ (MTAI)	Microchip Technology Thailand Branch (MMT)
Wire material	Au	Au	
Die attach material	3280	3280	
Molding compound material	G700LTD	G700LTD	
Lead frame material	C194	C194	

Impacts to Data Sheet:

None

Change Impact:

None



Reason for Change:

To improve on-time delivery performance by qualifying MMT as an additional assembly site

Change Implementation Status:

In progress

Estimated First Ship Date:

June 24, 2018 (date code:1826)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	January 2018					-->	May 2018					June 2018				
Workweek	01	02	03	04	05		18	19	20	21	22	23	24	25	26	
Initial PCN Issue Date				X												
Qual Report Availability										X						
Final PCN Issue Date										X						
Estimated Implementation Date															X	

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report

Revision History:

February 01, 2018: Issue initial notification

February 12, 2018: Re-issue initial notification to correct the file name of the affected CPN

May 24, 2018: Issued final notification. Attached is the qualification report. Updated the affected CPN list. Provided estimated first ship date to be on June 24, 2018.

The change described in this PCN does not alter Microchip’s current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

[PCN_LIAL-21URFI599 QUAL_REPORT.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to change your product/process change notification (PCN) profile please log on to our website at <http://www.microchip.com/PCN> sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to [microchipDIRECT](#) and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's



products or services."

Affected Catalog Part Numbers (CPN)

A010201-I/MQ
A010201T-I/MQ
A010201T-I/MQ050
AR1010-I/ML
AR1010T-I/ML
AR1011-I/ML
AR1011T-I/ML
AR1020-I/ML
AR1020T-I/ML
AR1021-I/ML
AR1021T-I/ML
AR1100-I/MQ
AR1100T-I/MQ
DSPIC30F1010-20E/MM
DSPIC30F1010-30I/MM
DSPIC30F2010-20E/MM
DSPIC30F2010-20I/MM
DSPIC30F2010-30I/MM
DSPIC30F2010T-20E/MM
DSPIC30F2010T-20I/MM
DSPIC30F2010T-30I/MM
DSPIC30F2010T-30V/MMA31
DSPIC30F2011-20I/ML
DSPIC30F2011-30I/ML
DSPIC30F2012-20E/ML
DSPIC30F2012-20I/ML
DSPIC30F2012-30I/ML
DSPIC30F2020-20E/MM
DSPIC30F2020-30I/MM
DSPIC30F2020T-30I/MM
DSPIC30F2023-20E/ML
DSPIC30F2023-30I/ML
DSPIC30F2023T-30I/ML
DSPIC30F2023T-30V/MLD31
DSPIC30F3010-20I/ML
DSPIC30F3010-30I/ML
DSPIC30F3010T-30I/ML
DSPIC30F3011-10I/MLB24
DSPIC30F3011-20E/ML
DSPIC30F3011-20I/ML
DSPIC30F3011-30I/ML
DSPIC30F3011T-10I/MLB21
DSPIC30F3012-20E/ML
DSPIC30F3012-20I/ML
DSPIC30F3012-30I/ML
DSPIC30F3012T-20I/ML
DSPIC30F3013-20E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC30F3013-30I/ML

DSPIC30F3013-30I/MLB31

DSPIC30F3013T-20I/ML

DSPIC30F3013T-30I/ML

DSPIC30F3013T-30I/MLB31

DSPIC30F3014-20E/ML

DSPIC30F3014-20I/ML

DSPIC30F3014-30I/ML

DSPIC30F3014-30I/MLA31

DSPIC30F3014T-30I/MLA31

DSPIC30F4011-20E/ML

DSPIC30F4011-20I/ML

DSPIC30F4011-30I/ML

DSPIC30F4012-20E/ML

DSPIC30F4012-20I/ML

DSPIC30F4012-30I/ML

DSPIC30F4013-20E/ML

DSPIC30F4013-20I/ML

DSPIC30F4013-30I/ML

DSPIC30F4013-30I/MLB31

DSPIC30F4013T-30I/ML

DSPIC30F4013T-30I/MLB31

DSPIC33EP128GM304-E/ML

DSPIC33EP128GM304-I/ML

DSPIC33EP128GM604-E/ML

DSPIC33EP128GM604-I/ML

DSPIC33EP128GP502-I/MM

DSPIC33EP128GP502T-I/MM

DSPIC33EP128GP504-E/ML

DSPIC33EP128GP504-H/ML

DSPIC33EP128GP504-I/ML

DSPIC33EP128GP504-I/MLA3

DSPIC33EP128GP504T-E/ML

DSPIC33EP128GP504T-I/ML

DSPIC33EP128MC202-E/MM

DSPIC33EP128MC202-I/MM

DSPIC33EP128MC202T-E/MM

DSPIC33EP128MC202T-I/MM

DSPIC33EP128MC204-E/ML

DSPIC33EP128MC204-H/ML

DSPIC33EP128MC204-I/ML

DSPIC33EP128MC204-I/MLA3

DSPIC33EP128MC204T-E/ML

DSPIC33EP128MC204T-I/ML

DSPIC33EP128MC502-I/MM

DSPIC33EP128MC502T-E/MM

DSPIC33EP128MC502T-I/MM

DSPIC33EP128MC504-E/ML

DSPIC33EP128MC504-H/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC33EP128MC504-I/MLA3

DSPIC33EP128MC504T-E/ML

DSPIC33EP128MC504T-H/ML

DSPIC33EP128MC504T-I/ML

DSPIC33EP16GS502-E/MM

DSPIC33EP16GS502-I/MM

DSPIC33EP16GS502T-E/MM

DSPIC33EP16GS502T-I/MM

DSPIC33EP16GS504-E/ML

DSPIC33EP16GS504-I/ML

DSPIC33EP16GS504T-E/ML

DSPIC33EP16GS504T-I/ML

DSPIC33EP256GM304-E/ML

DSPIC33EP256GM304-I/ML

DSPIC33EP256GM604-E/ML

DSPIC33EP256GM604-I/ML

DSPIC33EP256GP502-E/MM

DSPIC33EP256GP502-H/MM

DSPIC33EP256GP502-I/MM

DSPIC33EP256GP502T-E/MM

DSPIC33EP256GP502T-H/MM

DSPIC33EP256GP502T-I/MM

DSPIC33EP256GP504-E/ML

DSPIC33EP256GP504-H/ML

DSPIC33EP256GP504-I/ML

DSPIC33EP256GP504T-E/ML

DSPIC33EP256GP504T-H/ML

DSPIC33EP256GP504T-I/ML

DSPIC33EP256MC202-E/MM

DSPIC33EP256MC202-H/MM

DSPIC33EP256MC202-I/MM

DSPIC33EP256MC202T-E/MM

DSPIC33EP256MC202T-H/MM

DSPIC33EP256MC202T-I/MM

DSPIC33EP256MC204-E/ML

DSPIC33EP256MC204-H/ML

DSPIC33EP256MC204-I/ML

DSPIC33EP256MC204T-E/ML

DSPIC33EP256MC204T-E/MLC02

DSPIC33EP256MC204T-H/ML

DSPIC33EP256MC204T-I/ML

DSPIC33EP256MC502-E/MM

DSPIC33EP256MC502-H/MM

DSPIC33EP256MC502-I/MM

DSPIC33EP256MC502T-E/MM

DSPIC33EP256MC502T-H/MM

DSPIC33EP256MC502T-I/MM

DSPIC33EP256MC504-E/ML

DSPIC33EP256MC504-H/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC33EP256MC504T-E/ML
DSPIC33EP256MC504T-H/ML
DSPIC33EP256MC504T-I/ML
DSPIC33EP32GP502-E/MM
DSPIC33EP32GP502-I/MM
DSPIC33EP32GP502T-E/MM
DSPIC33EP32GP502T-I/MM
DSPIC33EP32GP504-E/ML
DSPIC33EP32GP504-H/ML
DSPIC33EP32GP504-I/ML
DSPIC33EP32GP504T-E/ML
DSPIC33EP32GP504T-H/ML
DSPIC33EP32GP504T-I/ML
DSPIC33EP32GS402-I/MM
DSPIC33EP32GS402-I/MMC01
DSPIC33EP32GS402T-I/MM
DSPIC33EP32GS402T-I/MMC01
DSPIC33EP32GS502-E/MM
DSPIC33EP32GS502-I/MM
DSPIC33EP32GS502T-E/MM
DSPIC33EP32GS502T-I/MM
DSPIC33EP32GS504-E/ML
DSPIC33EP32GS504-I/ML
DSPIC33EP32GS504-I/MLC09
DSPIC33EP32GS504-I/MLC10
DSPIC33EP32GS504T-E/ML
DSPIC33EP32GS504T-I/ML
DSPIC33EP32GS504T-I/MLC09
DSPIC33EP32GS504T-I/MLC10
DSPIC33EP32MC202-E/MM
DSPIC33EP32MC202-H/MM
DSPIC33EP32MC202-I/MM
DSPIC33EP32MC202T-E/MM
DSPIC33EP32MC202T-I/MM
DSPIC33EP32MC204-E/ML
DSPIC33EP32MC204-H/ML
DSPIC33EP32MC204-I/ML
DSPIC33EP32MC204T-E/ML
DSPIC33EP32MC204T-H/ML
DSPIC33EP32MC204T-I/ML
DSPIC33EP32MC502-E/MM
DSPIC33EP32MC502-I/MM
DSPIC33EP32MC502T-E/MM
DSPIC33EP32MC502T-I/MM
DSPIC33EP32MC504-E/ML
DSPIC33EP32MC504-H/ML
DSPIC33EP32MC504-I/ML
DSPIC33EP32MC504T-E/ML
DSPIC33EP32MC504T-H/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

DSPIC33EP512GM304-E/ML
DSPIC33EP512GM304-I/ML
DSPIC33EP512GM604-E/ML
DSPIC33EP512GM604-I/ML
DSPIC33EP512GP502-E/MM
DSPIC33EP512GP502-H/MM
DSPIC33EP512GP502-I/MM
DSPIC33EP512GP502T-E/MM
DSPIC33EP512GP502T-H/MM
DSPIC33EP512GP502T-I/MM
DSPIC33EP512GP504-E/ML
DSPIC33EP512GP504-H/ML
DSPIC33EP512GP504-I/ML
DSPIC33EP512GP504T-H/ML
DSPIC33EP512GP504T-I/ML
DSPIC33EP512MC202-E/MM
DSPIC33EP512MC202-H/MM
DSPIC33EP512MC202-I/MM
DSPIC33EP512MC202T-H/MM
DSPIC33EP512MC204-E/ML
DSPIC33EP512MC204-H/ML
DSPIC33EP512MC204-I/ML
DSPIC33EP512MC204T-E/ML
DSPIC33EP512MC204T-H/ML
DSPIC33EP512MC204T-I/ML
DSPIC33EP512MC502-E/MM
DSPIC33EP512MC502-H/MM
DSPIC33EP512MC502-I/MM
DSPIC33EP512MC502T-E/MM
DSPIC33EP512MC502T-H/MM
DSPIC33EP512MC504-E/ML
DSPIC33EP512MC504-H/ML
DSPIC33EP512MC504-I/ML
DSPIC33EP512MC504T-E/ML
DSPIC33EP512MC504T-H/ML
DSPIC33EP512MC504T-I/ML
DSPIC33EP64GP502-E/MM
DSPIC33EP64GP502-H/MM
DSPIC33EP64GP502-I/MM
DSPIC33EP64GP502T-E/MM
DSPIC33EP64GP502T-H/MM
DSPIC33EP64GP504-E/ML
DSPIC33EP64GP504-H/ML
DSPIC33EP64GP504-I/ML
DSPIC33EP64GP504-I/MLA3
DSPIC33EP64GP504T-E/ML
DSPIC33EP64GP504T-H/ML
DSPIC33EP64GP504T-I/ML
DSPIC33EP64GS402-I/MMC02

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

DSPIC33EP64GS502-E/MM

DSPIC33EP64GS502-I/MM

DSPIC33EP64GS502-I/MMC07

DSPIC33EP64GS502-I/MMC12

DSPIC33EP64GS502T-E/MM

DSPIC33EP64GS502T-I/MM

DSPIC33EP64GS502T-I/MMC07

DSPIC33EP64GS502T-I/MMC12

DSPIC33EP64GS504-E/ML

DSPIC33EP64GS504-E/MLC06

DSPIC33EP64GS504-I/ML

DSPIC33EP64GS504-I/MLC11

DSPIC33EP64GS504T-E/ML

DSPIC33EP64GS504T-I/ML

DSPIC33EP64GS504T-I/MLC11

DSPIC33EP64MC202-E/MM

DSPIC33EP64MC202-H/MM

DSPIC33EP64MC202-I/MM

DSPIC33EP64MC202T-E/MM

DSPIC33EP64MC202T-H/MM

DSPIC33EP64MC202T-I/MM

DSPIC33EP64MC204-E/ML

DSPIC33EP64MC204-H/ML

DSPIC33EP64MC204-I/ML

DSPIC33EP64MC204T-E/ML

DSPIC33EP64MC204T-H/ML

DSPIC33EP64MC204T-I/ML

DSPIC33EP64MC502-E/MM

DSPIC33EP64MC502-H/MM

DSPIC33EP64MC502-I/MM

DSPIC33EP64MC502T-E/MM

DSPIC33EP64MC502T-H/MM

DSPIC33EP64MC502T-I/MM

DSPIC33EP64MC504-E/ML

DSPIC33EP64MC504-H/ML

DSPIC33EP64MC504-I/ML

DSPIC33EP64MC504T-E/ML

DSPIC33EP64MC504T-H/ML

DSPIC33EP64MC504T-I/ML

DSPIC33EV128GM002-E/MM

DSPIC33EV128GM002-H/MM

DSPIC33EV128GM002-I/MM

DSPIC33EV128GM002T-I/MM

DSPIC33EV128GM004-E/ML

DSPIC33EV128GM004-H/ML

DSPIC33EV128GM004-I/ML

DSPIC33EV128GM004T-I/ML

DSPIC33EV128GM102-E/MM

DSPIC33EV128GM102-H/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

DSPIC33EV128GM102T-I/MM
DSPIC33EV128GM104-E/ML
DSPIC33EV128GM104-H/ML
DSPIC33EV128GM104-I/ML
DSPIC33EV128GM104T-I/ML
DSPIC33EV256GM002-E/MM
DSPIC33EV256GM002-H/MM
DSPIC33EV256GM002-I/MM
DSPIC33EV256GM002T-I/MM
DSPIC33EV256GM004-E/ML
DSPIC33EV256GM004-H/ML
DSPIC33EV256GM004-I/ML
DSPIC33EV256GM004T-I/ML
DSPIC33EV256GM102-E/MM
DSPIC33EV256GM102-H/MM
DSPIC33EV256GM102-I/MM
DSPIC33EV256GM102T-I/MM
DSPIC33EV256GM104-E/ML
DSPIC33EV256GM104-H/ML
DSPIC33EV256GM104-I/ML
DSPIC33EV256GM104T-I/ML
DSPIC33EV32GM002-E/MM
DSPIC33EV32GM002-H/MM
DSPIC33EV32GM002-I/MM
DSPIC33EV32GM002T-I/MM
DSPIC33EV32GM004-E/ML
DSPIC33EV32GM004-H/ML
DSPIC33EV32GM004-I/ML
DSPIC33EV32GM004T-I/ML
DSPIC33EV32GM102-E/MM
DSPIC33EV32GM102-H/MM
DSPIC33EV32GM102-I/MM
DSPIC33EV32GM102T-I/MM
DSPIC33EV32GM104-E/ML
DSPIC33EV32GM104-H/ML
DSPIC33EV32GM104-I/ML
DSPIC33EV32GM104T-I/ML
DSPIC33EV64GM002-E/MM
DSPIC33EV64GM002-H/MM
DSPIC33EV64GM002-I/MM
DSPIC33EV64GM002T-I/MM
DSPIC33EV64GM004-E/ML
DSPIC33EV64GM004-H/ML
DSPIC33EV64GM004-I/ML
DSPIC33EV64GM004T-I/ML
DSPIC33EV64GM102-E/MM
DSPIC33EV64GM102-H/MM
DSPIC33EV64GM102-I/MM
DSPIC33EV64GM102T-I/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC33EV64GM104-H/ML
DSPIC33EV64GM104-I/ML
DSPIC33EV64GM104T-I/ML
DSPIC33FJ06GS102A-E/MM
DSPIC33FJ06GS102A-I/MM
DSPIC33FJ06GS102AT-E/MM
DSPIC33FJ06GS102AT-I/MM
DSPIC33FJ06GS102-E/MM
DSPIC33FJ06GS102-I/MM
DSPIC33FJ06GS102T-E/MM
DSPIC33FJ06GS102T-I/MM
DSPIC33FJ06GS202A-E/MM
DSPIC33FJ06GS202A-I/MM
DSPIC33FJ06GS202AT-E/MM
DSPIC33FJ06GS202AT-I/MM
DSPIC33FJ06GS202-E/MM
DSPIC33FJ06GS202-E/MMC04
DSPIC33FJ06GS202-I/MM
DSPIC33FJ06GS202T-E/MM
DSPIC33FJ06GS202T-E/MMC04
DSPIC33FJ06GS202T-E/MMC06
DSPIC33FJ06GS202T-I/MM
DSPIC33FJ09GS302-E/MM
DSPIC33FJ09GS302-I/MM
DSPIC33FJ09GS302T-E/MM
DSPIC33FJ09GS302T-I/MM
DSPIC33FJ128GP202-E/MM
DSPIC33FJ128GP202-I/MM
DSPIC33FJ128GP202T-E/MM
DSPIC33FJ128GP202T-I/MM
DSPIC33FJ128GP204-E/ML
DSPIC33FJ128GP204-I/ML
DSPIC33FJ128GP204T-E/ML
DSPIC33FJ128GP204T-I/ML
DSPIC33FJ128GP802-E/MM
DSPIC33FJ128GP802-I/MM
DSPIC33FJ128GP802T-E/MM
DSPIC33FJ128GP802T-I/MM
DSPIC33FJ128GP802T-I/MM038
DSPIC33FJ128GP802T-I/MM039
DSPIC33FJ128GP804-E/ML
DSPIC33FJ128GP804-H/ML
DSPIC33FJ128GP804-I/ML
DSPIC33FJ128GP804T-E/ML
DSPIC33FJ128GP804T-H/ML
DSPIC33FJ128GP804T-I/ML
DSPIC33FJ128MC202-E/MM
DSPIC33FJ128MC202-I/MM
DSPIC33FJ128MC202T-E/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC33FJ128MC204-E/ML
DSPIC33FJ128MC204-I/ML
DSPIC33FJ128MC204T-E/ML
DSPIC33FJ128MC204T-I/ML
DSPIC33FJ128MC802-E/MM
DSPIC33FJ128MC802-H/MM
DSPIC33FJ128MC802-I/MM
DSPIC33FJ128MC802T-E/MM
DSPIC33FJ128MC802T-H/MM
DSPIC33FJ128MC802T-I/MM
DSPIC33FJ128MC804-E/ML
DSPIC33FJ128MC804-H/ML
DSPIC33FJ128MC804-I/ML
DSPIC33FJ128MC804T-E/ML
DSPIC33FJ128MC804T-H/ML
DSPIC33FJ128MC804T-I/ML
DSPIC33FJ12GP202-E/ML
DSPIC33FJ12GP202-I/ML
DSPIC33FJ12GP202T-E/ML
DSPIC33FJ12GP202T-I/ML
DSPIC33FJ12MC202-E/ML
DSPIC33FJ12MC202-I/ML
DSPIC33FJ12MC202T-E/ML
DSPIC33FJ12MC202T-I/ML
DSPIC33FJ16GP102-E/ML
DSPIC33FJ16GP102-H/ML
DSPIC33FJ16GP102-I/ML
DSPIC33FJ16GP102T-E/ML
DSPIC33FJ16GP102T-I/ML
DSPIC33FJ16GP304-I/ML
DSPIC33FJ16GP304T-E/ML
DSPIC33FJ16GP304T-I/ML
DSPIC33FJ16GS402-50I/MM
DSPIC33FJ16GS402-E/MM
DSPIC33FJ16GS402-H/MM
DSPIC33FJ16GS402-I/MM
DSPIC33FJ16GS402T-50I/MM
DSPIC33FJ16GS402T-E/MM
DSPIC33FJ16GS402T-H/MM
DSPIC33FJ16GS402T-I/MM
DSPIC33FJ16GS404-50I/ML
DSPIC33FJ16GS404-E/ML
DSPIC33FJ16GS404-H/ML
DSPIC33FJ16GS404-I/ML
DSPIC33FJ16GS404T-50I/ML
DSPIC33FJ16GS404T-E/ML
DSPIC33FJ16GS404T-H/ML
DSPIC33FJ16GS404T-I/ML
DSPIC33FJ16GS502-50I/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

DSPIC33FJ16GS502-E/MMC03

DSPIC33FJ16GS502-H/MM

DSPIC33FJ16GS502-I/MM

DSPIC33FJ16GS502T-50I/MM

DSPIC33FJ16GS502T-E/MM

DSPIC33FJ16GS502T-E/MMC03

DSPIC33FJ16GS502T-H/MM

DSPIC33FJ16GS502T-I/MM

DSPIC33FJ16GS504-50I/ML

DSPIC33FJ16GS504-E/ML

DSPIC33FJ16GS504-H/ML

DSPIC33FJ16GS504-I/ML

DSPIC33FJ16GS504T-50I/ML

DSPIC33FJ16GS504T-E/ML

DSPIC33FJ16GS504T-H/ML

DSPIC33FJ16GS504T-I/ML

DSPIC33FJ16MC102-E/ML

DSPIC33FJ16MC102-H/ML

DSPIC33FJ16MC102-I/ML

DSPIC33FJ16MC102T-E/ML

DSPIC33FJ16MC102T-I/ML

DSPIC33FJ16MC304-E/ML

DSPIC33FJ16MC304-H/ML

DSPIC33FJ16MC304-I/ML

DSPIC33FJ16MC304T-E/ML

DSPIC33FJ16MC304T-I/ML

DSPIC33FJ32GP104-I/ML

DSPIC33FJ32GP202-E/MM

DSPIC33FJ32GP202-I/MM

DSPIC33FJ32GP202T-E/MM

DSPIC33FJ32GP202T-I/MM

DSPIC33FJ32GP204-I/ML

DSPIC33FJ32GP204T-E/ML

DSPIC33FJ32GP204T-I/ML

DSPIC33FJ32GP302-E/MM

DSPIC33FJ32GP302-I/MM

DSPIC33FJ32GP302T-E/MM

DSPIC33FJ32GP302T-E/MMC03

DSPIC33FJ32GP302T-I/MM

DSPIC33FJ32GP304-E/ML

DSPIC33FJ32GP304-I/ML

DSPIC33FJ32GP304T-E/ML

DSPIC33FJ32GP304T-I/ML

DSPIC33FJ32MC102-I/ML

DSPIC33FJ32MC202-E/MM

DSPIC33FJ32MC202-H/MM

DSPIC33FJ32MC202-I/MM

DSPIC33FJ32MC202T-E/MM

DSPIC33FJ32MC202T-H/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

DSPIC33FJ32MC204-E/ML

DSPIC33FJ32MC204-H/ML

DSPIC33FJ32MC204-I/ML

DSPIC33FJ32MC204T-E/ML

DSPIC33FJ32MC204T-I/ML

DSPIC33FJ32MC204T-V/MLC21

DSPIC33FJ32MC204-V/MLC21

DSPIC33FJ32MC302-E/MM

DSPIC33FJ32MC302-I/MM

DSPIC33FJ32MC302T-E/MM

DSPIC33FJ32MC302T-I/MM

DSPIC33FJ32MC304-E/ML

DSPIC33FJ32MC304-I/ML

DSPIC33FJ32MC304T-E/ML

DSPIC33FJ32MC304T-I/ML

DSPIC33FJ64GP202-E/MM

DSPIC33FJ64GP202-I/MM

DSPIC33FJ64GP202T-E/MM

DSPIC33FJ64GP202T-I/MM

DSPIC33FJ64GP204-E/ML

DSPIC33FJ64GP204-I/ML

DSPIC33FJ64GP204T-E/ML

DSPIC33FJ64GP204T-I/ML

DSPIC33FJ64GP802-E/MM

DSPIC33FJ64GP802-H/MM

DSPIC33FJ64GP802-I/MM

DSPIC33FJ64GP802-I/MMB21

DSPIC33FJ64GP802T-E/MM

DSPIC33FJ64GP802T-E/MM032

DSPIC33FJ64GP802T-E/MM041

DSPIC33FJ64GP802T-H/MM

DSPIC33FJ64GP802T-I/MM

DSPIC33FJ64GP802T-I/MMB21

DSPIC33FJ64GP804-E/ML

DSPIC33FJ64GP804-I/ML

DSPIC33FJ64GP804T-E/ML

DSPIC33FJ64GP804T-I/ML

DSPIC33FJ64MC202-E/MM

DSPIC33FJ64MC202-E/MMC04

DSPIC33FJ64MC202-I/MM

DSPIC33FJ64MC202-I/MM030

DSPIC33FJ64MC202-I/MMC21

DSPIC33FJ64MC202T-E/MM

DSPIC33FJ64MC202T-E/MMC04

DSPIC33FJ64MC202T-I/MM

DSPIC33FJ64MC202T-I/MM030

DSPIC33FJ64MC202T-I/MMC21

DSPIC33FJ64MC204-E/ML

DSPIC33FJ64MC204-E/ML042

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

DSPIC33FJ64MC204T-E/ML

DSPIC33FJ64MC204T-E/ML042

DSPIC33FJ64MC204T-I/ML

DSPIC33FJ64MC802-E/MM

DSPIC33FJ64MC802-H/MM

DSPIC33FJ64MC802-I/MM

DSPIC33FJ64MC802T-E/MM

DSPIC33FJ64MC802T-H/MM

DSPIC33FJ64MC802T-I/MM

DSPIC33FJ64MC804-E/ML

DSPIC33FJ64MC804-H/ML

DSPIC33FJ64MC804-I/ML

DSPIC33FJ64MC804T-E/ML

DSPIC33FJ64MC804T-H/ML

DSPIC33FJ64MC804T-I/ML

ENC28J60-I/ML

ENC28J60T-I/ML

ENC424J600-I/ML

ENC424J600T-I/ML

HA2223-I/ML

HA2223T-I/ML

HA7612-I/MM033

HA7612-I/MM036

HA7612T-I/MM033

HA7612T-I/MM036

HA7617-I/ML035

HA7617-I/ML040

HA7617T-I/ML035

HA7617T-I/ML040

HA7617T-I/ML044

HA7617T-I/ML046

HA7619-I/ML027

HA7619-I/MM028

HA7619T-I/ML025

HA7619T-I/ML027

HA7619T-I/MM028

MCP19111-E/MQ

MCP19111T-E/MQ

MCP19114-E/MQ

MCP19114T-E/MQ

MCP19115-E/MQ

MCP19115T-E/MQ

MCP19117-E/MQ

MCP19117T-E/MQ

MCP19119-E/MQ

MCP19119T-E/MQ

MCP19123-E/MQ

MCP19123T-E/MQ

MCP19125-E/MQ

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

MCP2036-I/MG

MCP2036T-I/MG

MCP2200-E/MQ046

MCP2200-I/MQ

MCP2200-I/MQ031

MCP2200-I/MQ046

MCP2200-I/MQRVB

MCP2200T-E/MQ046

MCP2200T-I/MQ

MCP2200T-I/MQ031

MCP2200T-I/MQ046

MCP2200T-I/MQRVB

MCP2210-I/MQ

MCP2210T-I/MQ

MCP2221A-I/ML

MCP2221AT-I/ML

MCP2221-I/ML

MCP2221T-I/ML

MCP23016-I/ML

MCP23016T-I/ML

MCP23017-E/ML

MCP23017T-E/ML

MCP23S17-E/ML

MCP23S17T-E/ML

MCP3901A0-E/ML

MCP3901A0-I/ML

MCP3901A0T-E/ML

MCP3901A0T-I/ML

MCP3910A1-E/ML

MCP3910A1T-E/ML

MCP3911A0-E/ML

MCP3911A0T-E/ML

MCP3912A1-E/MQ

MCP3912A1T-E/MQ

MCP3918A1-E/ML

MCP3918A1T-E/ML

MCP3919A1-E/MQ

MCP3919A1T-E/MQ

MCP41HV31-103E/MQ

MCP41HV31-104E/MQ

MCP41HV31-502E/MQ

MCP41HV31-503E/MQ

MCP41HV31T-103E/MQ

MCP41HV31T-104E/MQ

MCP41HV31T-502E/MQ

MCP41HV31T-503E/MQ

MCP41HV51-103E/MQ

MCP41HV51-104E/MQ

MCP41HV51-502E/MQ

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

MCP41HV51T-I03E/MQ

MCP41HV51T-104E/MQ

MCP41HV51T-502E/MQ

MCP41HV51T-503E/MQ

MCP4231-103E/ML

MCP4231-104E/ML

MCP4231-502E/ML

MCP4231-503E/ML

MCP4231T-103E/ML

MCP4231T-104E/ML

MCP4231T-502E/ML

MCP4231T-503E/ML

MCP4241-103E/ML

MCP4241-104E/ML

MCP4241-502E/ML

MCP4241-503E/ML

MCP4241T-103E/ML

MCP4241T-104E/ML

MCP4241T-502E/ML

MCP4241T-503E/ML

MCP4251-103E/ML

MCP4251-104E/ML

MCP4251-502E/ML

MCP4251-503E/ML

MCP4251T-103E/ML

MCP4251T-104E/ML

MCP4251T-502E/ML

MCP4251T-503E/ML

MCP4261-103E/ML

MCP4261-104E/ML

MCP4261-502E/ML

MCP4261-503E/ML

MCP4261T-103E/ML

MCP4261T-104E/ML

MCP4261T-502E/ML

MCP4261T-503E/ML

MCP4331-103E/ML

MCP4331-104E/ML

MCP4331-502E/ML

MCP4331-503E/ML

MCP4331T-103E/ML

MCP4331T-104E/ML

MCP4331T-502E/ML

MCP4331T-503E/ML

MCP4341-103E/ML

MCP4341-104E/ML

MCP4341-502E/ML

MCP4341-503E/ML

MCP4341T-103E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

MCP4341T-502E/ML
MCP4341T-503E/ML
MCP4351-103E/ML
MCP4351-104E/ML
MCP4351-502E/ML
MCP4351-503E/ML
MCP4351T-103E/ML
MCP4351T-104E/ML
MCP4351T-502E/ML
MCP4351T-503E/ML
MCP4361-103E/ML
MCP4361-104E/ML
MCP4361-502E/ML
MCP4361-503E/ML
MCP4361T-103E/ML
MCP4361T-104E/ML
MCP4361T-502E/ML
MCP4361T-503E/ML
MCP4431-103E/ML
MCP4431-104E/ML
MCP4431-502E/ML
MCP4431-503E/ML
MCP4431T-103E/ML
MCP4431T-104E/ML
MCP4431T-502E/ML
MCP4431T-503E/ML
MCP4441-103E/ML
MCP4441-104E/ML
MCP4441-502E/ML
MCP4441-503E/ML
MCP4441T-103E/ML
MCP4441T-104E/ML
MCP4441T-502E/ML
MCP4441T-503E/ML
MCP4451-103E/ML
MCP4451-104E/ML
MCP4451-502E/ML
MCP4451-503E/ML
MCP4451T-103E/ML
MCP4451T-104E/ML
MCP4451T-502E/ML
MCP4451T-503E/ML
MCP4461-103E/ML
MCP4461-104E/ML
MCP4461-502E/ML
MCP4461-503E/ML
MCP4461T-103E/ML
MCP4461T-104E/ML
MCP4461T-502E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

MCP45HV31-I03E/MQ
MCP45HV31-104E/MQ
MCP45HV31-502E/MQ
MCP45HV31-503E/MQ
MCP45HV31T-103E/MQ
MCP45HV31T-104E/MQ
MCP45HV31T-502E/MQ
MCP45HV31T-503E/MQ
MCP45HV51-103E/MQ
MCP45HV51-104E/MQ
MCP45HV51-502E/MQ
MCP45HV51-503E/MQ
MCP45HV51T-103E/MQ
MCP45HV51T-104E/MQ
MCP45HV51T-502E/MQ
MCP45HV51T-503E/MQ
MCP4631T-103E/ML
MCP4631T-104E/ML
MCP4631T-502E/ML
MCP4631T-503E/ML
MCP4641T-103E/ML
MCP4641T-104E/ML
MCP4641T-502E/ML
MCP4641T-503E/ML
MCP4651T-103E/ML
MCP4651T-104E/ML
MCP4651T-502E/ML
MCP4651T-503E/ML
MCP4661T-103E/ML
MCP4661T-104E/ML
MCP4661T-104QE/ML
MCP4661T-502E/ML
MCP4661T-503E/ML
MCP4661T-503QE/ML
MTCH105-I/ML
MTCH105T-I/ML
MTCH6301-I/ML
MTCH6301T-I/ML
PIC16F1454-E/ML
PIC16F1454-I/ML
PIC16F1454T-I/ML
PIC16F1455-E/ML
PIC16F1455-I/ML
PIC16F1455-I/MLC02
PIC16F1455T-I/ML
PIC16F1455T-I/MLC02
PIC16F1459-E/ML
PIC16F1459-I/ML
PIC16F1459-I/MLC01

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16F1459T-I/ML020
PIC16F1459T-I/MLC01
PIC16F1503-E/MG
PIC16F1503-I/MG
PIC16F1503-I/MG031
PIC16F1503-I/MGC02
PIC16F1503T-E/MG
PIC16F1503T-E/MG033
PIC16F1503T-E/MG039
PIC16F1503T-I/MG
PIC16F1503T-I/MG027
PIC16F1503T-I/MG028
PIC16F1503T-I/MG029
PIC16F1503T-I/MG030
PIC16F1503T-I/MG031
PIC16F1503T-I/MG032
PIC16F1503T-I/MG035
PIC16F1503T-I/MG037
PIC16F1503T-I/MG043
PIC16F1503T-I/MG044
PIC16F1503T-I/MG048
PIC16F1503T-I/MGC02
PIC16F1507-E/ML
PIC16F1507-I/ML
PIC16F1507T-E/ML
PIC16F1507T-I/ML
PIC16F1508-E/ML
PIC16F1508-I/ML
PIC16F1508T-E/ML
PIC16F1508T-I/ML
PIC16F1508T-I/MLOPP
PIC16F1509-E/ML
PIC16F1509-I/ML
PIC16F1509-I/ML045
PIC16F1509T-E/ML
PIC16F1509T-I/ML
PIC16F1509T-I/ML045
PIC16F1516-E/ML
PIC16F1516-I/ML
PIC16F1516T-I/ML
PIC16F1518-E/ML
PIC16F1518-I/ML
PIC16F1518T-I/ML
PIC16F15354-E/ML
PIC16F15354-I/ML
PIC16F15354T-I/ML
PIC16F15355-E/ML
PIC16F15355-I/ML
PIC16F15355T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC16FI5375-I/ML
PIC16F15375T-I/ML
PIC16F15376-E/ML
PIC16F15376-I/ML
PIC16F15376T-I/ML
PIC16F1613-E/ML
PIC16F1613-I/ML
PIC16F1613T-I/ML
PIC16F1613T-I/ML023
PIC16F1614-E/ML
PIC16F1614-I/ML
PIC16F1614T-I/ML
PIC16F1615-E/ML
PIC16F1615-I/ML
PIC16F1615T-E/ML
PIC16F1615T-I/ML
PIC16F1618-E/ML
PIC16F1618-I/ML
PIC16F1618T-I/ML
PIC16F1619-E/ML
PIC16F1619-I/ML
PIC16F1619T-I/ML
PIC16F1703-E/ML
PIC16F1703-I/ML
PIC16F1703T-I/ML
PIC16F1704-E/ML
PIC16F1704-I/ML
PIC16F1704T-E/ML
PIC16F1704T-I/ML
PIC16F1705-E/ML
PIC16F1705-I/ML
PIC16F1705T-E/ML
PIC16F1705T-I/ML
PIC16F1707-E/ML
PIC16F1707-I/ML
PIC16F1707T-I/ML
PIC16F1708-E/ML
PIC16F1708-E/ML028
PIC16F1708-I/ML
PIC16F1708T-E/ML
PIC16F1708T-E/ML025
PIC16F1708T-E/ML026
PIC16F1708T-E/ML027
PIC16F1708T-E/ML028
PIC16F1708T-E/ML030
PIC16F1708T-I/ML
PIC16F1709-E/ML
PIC16F1709-I/ML
PIC16F1709-I/ML020

PIC16F1709T-I/ML

PIC16F1709T-I/ML020

PIC16F1713-E/ML

PIC16F1713-I/ML

PIC16F1713T-I/ML

PIC16F1716-E/ML

PIC16F1716-I/ML

PIC16F1716T-I/ML

PIC16F1717-E/ML

PIC16F1717-I/ML

PIC16F1717T-I/ML

PIC16F1718-E/ML

PIC16F1718-I/ML

PIC16F1718T-I/ML

PIC16F1719-E/ML

PIC16F1719-I/ML

PIC16F1719T-I/ML

PIC16F1764-E/ML

PIC16F1764-I/ML

PIC16F1764T-E/ML

PIC16F1764T-I/ML

PIC16F1765-E/ML

PIC16F1765-I/ML

PIC16F1765T-I/ML

PIC16F1768-E/ML

PIC16F1768-I/ML

PIC16F1768T-E/ML

PIC16F1768T-I/ML

PIC16F1769-E/ML

PIC16F1769-I/ML

PIC16F1769T-E/ML

PIC16F1769T-I/ML

PIC16F1777-E/ML

PIC16F1777-I/ML

PIC16F1777T-I/ML

PIC16F1779-E/ML

PIC16F1779-I/ML

PIC16F1779T-I/ML

PIC16F1782-E/ML

PIC16F1782-I/ML

PIC16F1782T-E/ML

PIC16F1782T-I/ML

PIC16F1783-E/ML

PIC16F1783-I/ML

PIC16F1783T-E/ML

PIC16F1783T-I/ML

PIC16F1784-E/ML

PIC16F1784-I/ML

PIC16F1784T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16F1786-I/ML

PIC16F1786T-I/ML

PIC16F1787-E/ML

PIC16F1787-I/ML

PIC16F1787T-E/ML021

PIC16F1787T-I/ML

PIC16F1787T-I/ML020

PIC16F1788-E/ML

PIC16F1788-I/ML

PIC16F1788T-E/ML

PIC16F1788T-I/ML

PIC16F1789-E/ML

PIC16F1789-I/ML

PIC16F1789T-I/ML

PIC16F1823-E/ML

PIC16F1823-I/ML

PIC16F1823-I/ML029

PIC16F1823-I/MLLS1

PIC16F1823T-E/ML

PIC16F1823T-I/ML

PIC16F1823T-I/ML029

PIC16F1824-E/ML

PIC16F1824-I/ML

PIC16F1824T-E/ML

PIC16F1824T-I/ML

PIC16F1824T-I/MLC01

PIC16F1824T-I/MLOPP

PIC16F1825-E/ML

PIC16F1825-H/ML

PIC16F1825-I/ML

PIC16F1825T-E/ML

PIC16F1825T-E/ML031

PIC16F1825T-H/ML

PIC16F1825T-I/ML

PIC16F1826-E/ML

PIC16F1826-I/ML

PIC16F1826T-I/ML

PIC16F1827-E/ML

PIC16F1827-I/ML

PIC16F1827T-I/ML

PIC16F1828-E/ML

PIC16F1828-E/MLC02

PIC16F1828-I/ML

PIC16F1828-I/MLC04

PIC16F1828T-E/ML

PIC16F1828T-I/ML

PIC16F1829-E/ML

PIC16F1829-H/ML

PIC16F1829-I/ML

PIC16F1829-I/ML031

PIC16F1829T-E/ML

PIC16F1829T-H/ML

PIC16F1829T-I/ML

PIC16F1829T-I/ML030

PIC16F1829T-I/ML031

PIC16F1847-E/ML

PIC16F1847-I/ML

PIC16F1847T-I/ML

PIC16F1933-E/ML

PIC16F1933-I/ML

PIC16F1933T-E/ML

PIC16F1933T-I/ML

PIC16F1934-E/ML

PIC16F1934-I/ML

PIC16F1934T-I/ML

PIC16F1936-E/ML

PIC16F1936-I/ML

PIC16F1936T-I/ML

PIC16F1937-E/ML

PIC16F1937-I/ML

PIC16F1937T-I/ML

PIC16F1938-E/ML

PIC16F1938-I/ML

PIC16F1938-I/MLRA2

PIC16F1938T-I/ML

PIC16F1938T-I/MLRA2

PIC16F1939-E/ML

PIC16F1939-I/ML

PIC16F1939T-I/ML

PIC16F505-E/MG

PIC16F505-I/MG

PIC16F505T-E/MG

PIC16F505T-I/MG

PIC16F506-E/MG

PIC16F506-I/MG

PIC16F506T-E/MG

PIC16F506T-I/MG

PIC16F526-E/MG

PIC16F526-I/MG

PIC16F526T-I/MG

PIC16F527-E/ML

PIC16F527-I/ML

PIC16F527T-I/ML

PIC16F570-E/ML

PIC16F570-I/ML

PIC16F570T-I/ML

PIC16F610-E/ML

PIC16F610-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16F610T-I/ML

PIC16F616-E/ML

PIC16F616-H/ML

PIC16F616-I/ML

PIC16F616T-E/ML

PIC16F616T-E/MLC07

PIC16F616T-I/ML

PIC16F616T-I/ML034

PIC16F616T-I/ML042

PIC16F616T-I/ML066

PIC16F627A-E/ML

PIC16F627A-I/ML

PIC16F627AT-I/ML

PIC16F628A-E/ML

PIC16F628A-I/ML

PIC16F628AT-E/ML

PIC16F628AT-I/ML

PIC16F630-E/ML

PIC16F630-I/ML

PIC16F630T-I/ML

PIC16F630T-I/ML079

PIC16F631-E/ML

PIC16F631-I/ML

PIC16F631T-I/ML

PIC16F636-I/ML

PIC16F636T-I/ML

PIC16F636T-I/ML037

PIC16F648A-E/ML

PIC16F648A-I/ML

PIC16F648AT-E/ML

PIC16F648AT-I/ML

PIC16F676-E/ML

PIC16F676-I/ML

PIC16F676T-I/ML

PIC16F677-E/ML

PIC16F677-I/ML

PIC16F677T-I/ML

PIC16F684-E/ML

PIC16F684-I/ML

PIC16F684T-I/ML

PIC16F684T-I/ML065

PIC16F684T-I/ML070

PIC16F685-E/ML

PIC16F685-I/ML

PIC16F685T-E/ML

PIC16F685T-I/ML

PIC16F687-E/ML

PIC16F687-E/ML034

PIC16F687-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16F687T-I/ML

PIC16F688-E/ML

PIC16F688-I/ML

PIC16F688T-I/ML

PIC16F688T-I/MLAPL

PIC16F689-E/ML

PIC16F689-I/ML

PIC16F689T-E/ML

PIC16F689T-I/ML

PIC16F690-E/ML

PIC16F690-I/ML

PIC16F690T-E/ML

PIC16F690T-I/ML

PIC16F690T-I/ML050

PIC16F690T-I/MLC12

PIC16F707-E/ML

PIC16F707-I/ML

PIC16F707T-I/ML

PIC16F720-E/ML

PIC16F720-I/ML

PIC16F720T-I/ML

PIC16F721-E/ML

PIC16F721-I/ML

PIC16F721T-E/ML

PIC16F721T-I/ML

PIC16F722A-E/ML

PIC16F722A-I/ML

PIC16F722AT-I/ML

PIC16F722-E/ML

PIC16F722-I/ML

PIC16F722T-I/ML

PIC16F723A-E/ML

PIC16F723A-I/ML

PIC16F723AT-E/ML

PIC16F723AT-I/ML

PIC16F723-E/ML

PIC16F723-I/ML

PIC16F723T-E/ML

PIC16F723T-I/ML

PIC16F724-E/ML

PIC16F724-I/ML

PIC16F724T-I/ML

PIC16F726-E/ML

PIC16F726-I/ML

PIC16F726T-I/ML

PIC16F727-E/ML

PIC16F727-I/ML

PIC16F727T-I/ML

PIC16F72-E/ML

PIC16F72T-I/ML
PIC16F737-E/ML
PIC16F737-I/ML
PIC16F737T-I/ML
PIC16F73-E/ML
PIC16F73-I/ML
PIC16F73T-I/ML
PIC16F747-I/ML
PIC16F747T-I/ML
PIC16F753-E/ML
PIC16F753-I/ML
PIC16F753T-I/ML
PIC16F767-E/ML
PIC16F767-I/ML
PIC16F767T-E/ML
PIC16F767T-I/ML
PIC16F76-I/ML
PIC16F76T-I/ML
PIC16F777-I/ML
PIC16F77-I/ML
PIC16F785-E/ML
PIC16F785-I/ML
PIC16F785T-E/ML
PIC16F785T-I/ML
PIC16F785T-I/ML036
PIC16F785T-I/ML045
PIC16F785T-I/ML047
PIC16F818-E/ML
PIC16F818-I/ML
PIC16F818T-I/ML
PIC16F819-E/ML
PIC16F819-I/ML
PIC16F819-I/MLTSL
PIC16F819T-E/ML
PIC16F819T-I/ML
PIC16F873A-E/ML
PIC16F873A-I/ML
PIC16F873AT-I/ML
PIC16F874A-I/ML
PIC16F874AT-I/ML
PIC16F876A-E/ML
PIC16F876A-I/ML
PIC16F876AT-E/ML
PIC16F876AT-I/ML
PIC16F877A-E/ML
PIC16F877A-I/ML
PIC16F877AT-I/ML
PIC16F87-I/ML
PIC16F882-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16F882T-I/ML

PIC16F883-E/ML

PIC16F883-I/ML

PIC16F883T-E/ML

PIC16F883T-I/ML

PIC16F883T-I/ML031

PIC16F884-E/ML

PIC16F884-I/ML

PIC16F884T-I/ML

PIC16F886-E/ML

PIC16F886-I/ML

PIC16F886T-E/ML

PIC16F886T-I/ML

PIC16F886T-I/MLC06

PIC16F887-E/ML

PIC16F887-I/ML

PIC16F887T-I/ML

PIC16F88-E/ML

PIC16F88-I/ML

PIC16F88T-I/ML

PIC16F913-E/ML

PIC16F913-I/ML

PIC16F913T-I/ML

PIC16F914-E/ML

PIC16F914-I/ML

PIC16F914T-I/ML

PIC16F916-E/ML

PIC16F916-I/ML

PIC16F916T-I/ML

PIC16F916T-I/MLC02

PIC16F917-E/ML

PIC16F917-I/ML

PIC16F917T-I/ML

PIC16HV610-E/ML

PIC16HV610-I/ML

PIC16HV610T-I/ML

PIC16HV616-E/ML

PIC16HV616-I/ML

PIC16HV616T-E/ML

PIC16HV616T-I/ML

PIC16HV753-E/ML

PIC16HV753-I/ML

PIC16HV753T-I/ML

PIC16HV785-E/ML

PIC16HV785-I/ML

PIC16HV785T-E/ML

PIC16HV785T-I/ML

PIC16LC72A-04I/ML

PIC16LF1454-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16LF1454T-I/ML
PIC16LF1455-E/ML
PIC16LF1455-I/ML
PIC16LF1455T-I/ML
PIC16LF1459-E/ML
PIC16LF1459-I/ML
PIC16LF1459-I/MLC01
PIC16LF1459-I/MLC02
PIC16LF1459-I/MLC03
PIC16LF1459T-I/ML
PIC16LF1459T-I/MLC01
PIC16LF1459T-I/MLC02
PIC16LF1459T-I/MLC03
PIC16LF1503-E/MG
PIC16LF1503-I/MG
PIC16LF1503T-E/MG
PIC16LF1503T-I/MG
PIC16LF1507-E/ML
PIC16LF1507-I/ML
PIC16LF1507T-I/ML
PIC16LF1508-E/ML
PIC16LF1508-I/ML
PIC16LF1508T-I/ML
PIC16LF1509-E/ML
PIC16LF1509-I/ML
PIC16LF1509T-I/ML
PIC16LF1516-E/ML
PIC16LF1516-I/ML
PIC16LF1516T-I/ML
PIC16LF1518-E/ML
PIC16LF1518-I/ML
PIC16LF1518T-I/ML
PIC16LF15354-E/ML
PIC16LF15354-I/ML
PIC16LF15354T-I/ML
PIC16LF15355-E/ML
PIC16LF15355-I/ML
PIC16LF15355T-I/ML
PIC16LF15375-E/ML
PIC16LF15375-I/ML
PIC16LF15375T-I/ML
PIC16LF15376-E/ML
PIC16LF15376-I/ML
PIC16LF15376T-I/ML
PIC16LF1554-E/ML
PIC16LF1554-I/ML
PIC16LF1554T-I/ML
PIC16LF1554T-I/ML023
PIC16LF1559-E/ML

PIC16LF1559T-I/ML
PIC16LF1613-E/ML
PIC16LF1613-I/ML
PIC16LF1613T-I/ML
PIC16LF1614-E/ML
PIC16LF1614-I/ML
PIC16LF1614T-I/ML
PIC16LF1615-E/ML
PIC16LF1615-I/ML
PIC16LF1615T-I/ML
PIC16LF1618-E/ML
PIC16LF1618-I/ML
PIC16LF1618T-I/ML
PIC16LF1619-E/ML
PIC16LF1619-I/ML
PIC16LF1619T-I/ML
PIC16LF1703-E/ML
PIC16LF1703-I/ML
PIC16LF1703T-I/ML
PIC16LF1704-E/ML
PIC16LF1704-I/ML
PIC16LF1704T-I/ML
PIC16LF1705-E/ML
PIC16LF1705-I/ML
PIC16LF1705T-I/ML
PIC16LF1707-E/ML
PIC16LF1707-I/ML
PIC16LF1707T-I/ML
PIC16LF1708-E/ML
PIC16LF1708-I/ML
PIC16LF1708T-I/ML
PIC16LF1709-E/ML
PIC16LF1709-I/ML
PIC16LF1709T-I/ML
PIC16LF1713-E/ML
PIC16LF1713-I/ML
PIC16LF1713T-I/ML
PIC16LF1716-E/ML
PIC16LF1716-I/ML
PIC16LF1716T-I/ML
PIC16LF1717-E/ML
PIC16LF1717-I/ML
PIC16LF1717T-I/ML
PIC16LF1718-E/ML
PIC16LF1718-I/ML
PIC16LF1718T-I/ML
PIC16LF1719-E/ML
PIC16LF1719-I/ML
PIC16LF1719T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16LF1764-I/ML

PIC16LF1764T-I/ML

PIC16LF1765-E/ML

PIC16LF1765-I/ML

PIC16LF1765T-I/ML

PIC16LF1768-E/ML

PIC16LF1768-I/ML

PIC16LF1768T-I/ML

PIC16LF1769-E/ML

PIC16LF1769-I/ML

PIC16LF1769T-I/ML

PIC16LF1777-E/ML

PIC16LF1777-I/ML

PIC16LF1777T-I/ML

PIC16LF1779-E/ML

PIC16LF1779-I/ML

PIC16LF1779T-I/ML

PIC16LF1782-E/ML

PIC16LF1782-I/ML

PIC16LF1782T-I/ML

PIC16LF1783-E/ML

PIC16LF1783-I/ML

PIC16LF1783T-I/ML

PIC16LF1784-E/ML

PIC16LF1784-I/ML

PIC16LF1784T-I/ML

PIC16LF1786-E/ML

PIC16LF1786-I/ML

PIC16LF1786T-I/ML

PIC16LF1787-E/ML

PIC16LF1787-I/ML

PIC16LF1787T-I/ML

PIC16LF1788-E/ML

PIC16LF1788-I/ML

PIC16LF1788T-I/ML

PIC16LF1789-E/ML

PIC16LF1789-I/ML

PIC16LF1789T-I/ML

PIC16LF1823-E/ML

PIC16LF1823-I/ML

PIC16LF1823-I/MLC04

PIC16LF1823-I/MLLS2

PIC16LF1823T-I/ML

PIC16LF1823T-I/MLC04

PIC16LF1823T-I/MLLS2

PIC16LF1824-E/ML

PIC16LF1824-I/ML

PIC16LF1824-I/MLC01

PIC16LF1824T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC16LF1825-E/ML

PIC16LF1825-I/ML

PIC16LF1825T-E/ML

PIC16LF1825T-I/ML

PIC16LF1826-E/ML

PIC16LF1826-I/ML

PIC16LF1826-I/MLC01

PIC16LF1826T-I/ML

PIC16LF1826T-I/MLC01

PIC16LF1827-E/ML

PIC16LF1827-I/ML

PIC16LF1827T-I/ML

PIC16LF1828-E/ML

PIC16LF1828-I/ML

PIC16LF1828T-I/ML

PIC16LF1828T-I/ML025

PIC16LF1829-E/ML

PIC16LF1829-I/ML

PIC16LF1829T-I/ML

PIC16LF1847-E/ML

PIC16LF1847-I/ML

PIC16LF1847T-I/ML

PIC16LF1933-E/ML

PIC16LF1933-I/ML

PIC16LF1933T-I/ML

PIC16LF1934-E/ML

PIC16LF1934-I/ML

PIC16LF1934T-I/ML

PIC16LF1936-E/ML

PIC16LF1936-I/ML

PIC16LF1936T-I/ML

PIC16LF1936T-I/ML020

PIC16LF1937-E/ML

PIC16LF1937-I/ML

PIC16LF1937T-I/ML

PIC16LF1938-E/ML

PIC16LF1938-I/ML

PIC16LF1938-I/MLC01

PIC16LF1938T-E/ML

PIC16LF1938T-I/ML

PIC16LF1938T-I/MLC01

PIC16LF1939-E/ML

PIC16LF1939-I/ML

PIC16LF1939T-I/ML

PIC16LF627A-I/ML

PIC16LF627AT-I/ML

PIC16LF628A-I/ML

PIC16LF628AT-I/ML

PIC16LF648A-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC16LF707-E/ML
PIC16LF707-I/ML
PIC16LF707T-I/ML
PIC16LF720-E/ML
PIC16LF720-I/ML
PIC16LF720T-I/ML
PIC16LF721-E/ML
PIC16LF721-I/ML
PIC16LF721T-I/ML
PIC16LF721T-I/ML022
PIC16LF721T-I/ML024
PIC16LF721T-I/ML025
PIC16LF721T-I/ML028
PIC16LF721T-I/ML030
PIC16LF722A-E/ML
PIC16LF722A-I/ML
PIC16LF722AT-I/ML
PIC16LF722-E/ML
PIC16LF722-I/ML
PIC16LF722T-I/ML
PIC16LF723A-E/ML
PIC16LF723A-I/ML
PIC16LF723AT-I/ML
PIC16LF723-E/ML
PIC16LF723-I/ML
PIC16LF723T-I/ML
PIC16LF724-E/ML
PIC16LF724-I/ML
PIC16LF724T-I/ML
PIC16LF726-E/ML
PIC16LF726-I/ML
PIC16LF726T-I/ML
PIC16LF727-E/ML
PIC16LF727-I/ML
PIC16LF727-I/MLC01
PIC16LF727T-I/ML
PIC16LF727T-I/MLC01
PIC16LF72-I/ML
PIC16LF72-I/ML026
PIC16LF72T-I/ML
PIC16LF737-I/ML
PIC16LF73-I/ML
PIC16LF73T-I/ML
PIC16LF767-I/ML
PIC16LF767T-I/ML
PIC16LF76-I/ML
PIC16LF76T-I/ML057
PIC16LF777-I/ML
PIC16LF818-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC16LF819-I/ML

PIC16LF819T-I/ML

PIC16LF873A-I/ML

PIC16LF873AT-I/ML

PIC16LF874A-I/ML

PIC16LF876A-I/ML

PIC16LF876AT-I/ML

PIC16LF877A-I/ML

PIC16LF87-I/ML

PIC16LF88-I/ML

PIC16LF88T-I/ML

PIC18F1220-E/ML

PIC18F1220-H/ML

PIC18F1220-I/ML

PIC18F1220T-I/ML

PIC18F1230-E/ML

PIC18F1230-I/ML

PIC18F1230-I/MLXXX

PIC18F1320-E/ML

PIC18F1320-H/ML

PIC18F1320-I/ML

PIC18F1320T-I/ML

PIC18F1330-E/ML

PIC18F1330-I/ML

PIC18F1330-I/MLXXX

PIC18F1330-ICD/ML

PIC18F13K22-E/ML

PIC18F13K22-E/MLC01

PIC18F13K22-I/ML

PIC18F13K22T-I/ML

PIC18F13K22T-I/ML020

PIC18F13K50-I/MQ

PIC18F13K50T-I/MQ

PIC18F14K22-E/ML

PIC18F14K22-I/ML

PIC18F14K22T-E/ML

PIC18F14K22T-I/ML

PIC18F14K50-E/MQ

PIC18F14K50-I/MQ

PIC18F14K50-I/MQ048

PIC18F14K50T-I/MQ

PIC18F14K50T-I/MQ029

PIC18F14K50T-I/MQ039

PIC18F14K50T-I/MQ044

PIC18F14K50T-I/MQ045

PIC18F14K50T-I/MQ047

PIC18F14K50T-I/MQ048

PIC18F2221-E/ML

PIC18F2221-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F2321-E/ML

PIC18F2321-I/ML

PIC18F2331-E/MM

PIC18F2331-I/MM

PIC18F2331T-I/MM

PIC18F23K20-E/ML

PIC18F23K20-I/ML

PIC18F23K20T-E/ML

PIC18F23K20T-I/ML

PIC18F23K22-E/ML

PIC18F23K22-I/ML

PIC18F23K22T-E/ML

PIC18F23K22T-I/ML

PIC18F2410-E/ML

PIC18F2410-I/ML

PIC18F2420-E/ML

PIC18F2420-I/ML

PIC18F2420T-E/ML

PIC18F2420T-I/ML

PIC18F2423-E/ML

PIC18F2423-I/ML

PIC18F2423T-I/ML

PIC18F2431-E/MM

PIC18F2431-I/MM

PIC18F2431T-E/MM

PIC18F2431T-I/MM

PIC18F2450-I/ML

PIC18F2450T-I/ML

PIC18F2480-E/ML

PIC18F2480-I/ML

PIC18F2480-I/MLC01

PIC18F2480T-E/ML

PIC18F2480T-I/ML

PIC18F24J10-I/ML

PIC18F24J10T-I/ML

PIC18F24J11-I/ML

PIC18F24J11T-I/ML

PIC18F24J50-I/ML

PIC18F24J50T-I/ML

PIC18F24K20-E/ML

PIC18F24K20-I/ML

PIC18F24K20T-I/ML

PIC18F24K20T-I/ML028

PIC18F24K22-E/ML

PIC18F24K22-I/ML

PIC18F24K22T-E/ML

PIC18F24K22T-I/ML

PIC18F24K42-E/ML

PIC18F24K42-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F24K50-E/ML

PIC18F24K50-I/ML

PIC18F24K50T-I/ML

PIC18F2510-E/ML

PIC18F2510-I/ML

PIC18F2510T-E/ML

PIC18F2510T-I/ML

PIC18F2520-E/ML

PIC18F2520-I/ML

PIC18F2520T-I/ML

PIC18F2523-E/ML

PIC18F2523-I/ML

PIC18F2523T-I/ML

PIC18F2580-E/ML

PIC18F2580-I/ML

PIC18F2580T-E/ML

PIC18F2580T-I/ML

PIC18F25J10-I/ML

PIC18F25J10-I/ML020

PIC18F25J10T-I/ML

PIC18F25J10T-I/ML020

PIC18F25J11-I/ML

PIC18F25J11T-I/ML

PIC18F25J50-I/ML

PIC18F25J50T-I/ML

PIC18F25K20-E/ML

PIC18F25K20-I/ML

PIC18F25K20-I/MLC02

PIC18F25K20-I/MLC05

PIC18F25K20-I/MLC10

PIC18F25K20-I/MLLPR

PIC18F25K20T-E/ML

PIC18F25K20T-I/ML

PIC18F25K20T-I/MLC02

PIC18F25K20T-I/MLC10

PIC18F25K22-E/ML

PIC18F25K22-I/ML

PIC18F25K22T-E/ML

PIC18F25K22T-I/ML

PIC18F25K42-E/ML

PIC18F25K42-I/ML

PIC18F25K42T-I/ML

PIC18F25K50-E/ML

PIC18F25K50-I/ML

PIC18F25K50T-E/ML

PIC18F25K50T-E/ML020

PIC18F25K50T-E/ML022

PIC18F25K50T-I/ML

PIC18F25K80-E/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F25K80-H/MM

PIC18F25K80-I/MM

PIC18F25K80-I/MM030

PIC18F25K80-I/MM031

PIC18F25K80-I/MM032

PIC18F25K80-I/MMC04

PIC18F25K80T-E/MM

PIC18F25K80T-E/MMC01

PIC18F25K80T-E/MMCUI

PIC18F25K80T-H/MM

PIC18F25K80T-I/MM

PIC18F25K80T-I/MM030

PIC18F25K80T-I/MM031

PIC18F25K80T-I/MM032

PIC18F25K80T-I/MMC04

PIC18F25K83-E/ML

PIC18F25K83-I/ML

PIC18F25K83T-I/ML

PIC18F26J11-I/ML

PIC18F26J11T-I/ML

PIC18F26J13-I/ML

PIC18F26J13T-I/ML

PIC18F26J50-I/ML

PIC18F26J50T-I/ML

PIC18F26J53-I/ML

PIC18F26J53T-I/ML

PIC18F26K20-E/ML

PIC18F26K20-I/ML

PIC18F26K20-I/ML035

PIC18F26K20-I/ML045

PIC18F26K20-I/ML046

PIC18F26K20-I/ML047

PIC18F26K20-I/ML048

PIC18F26K20-I/ML049

PIC18F26K20-I/ML050

PIC18F26K20-I/MLC03

PIC18F26K20T-E/ML

PIC18F26K20T-I/ML

PIC18F26K20T-I/ML033

PIC18F26K20T-I/ML034

PIC18F26K20T-I/ML035

PIC18F26K20T-I/ML036

PIC18F26K20T-I/ML040

PIC18F26K20T-I/ML043

PIC18F26K20T-I/ML045

PIC18F26K20T-I/ML046

PIC18F26K20T-I/ML047

PIC18F26K20T-I/ML048

PIC18F26K20T-I/ML049

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F26K20T-I/ML051
PIC18F26K20T-I/ML052
PIC18F26K20T-I/ML053
PIC18F26K20T-I/ML054
PIC18F26K20T-I/ML055
PIC18F26K20T-I/MLC03
PIC18F26K22-E/ML
PIC18F26K22-I/ML
PIC18F26K22-I/MLC03
PIC18F26K22T-E/ML
PIC18F26K22T-I/ML
PIC18F26K22T-I/ML024
PIC18F26K22T-I/MLC03
PIC18F26K42-E/ML
PIC18F26K42-I/ML
PIC18F26K42T-I/ML
PIC18F26K80-E/MM
PIC18F26K80-H/MM
PIC18F26K80-I/MM
PIC18F26K80T-E/MM
PIC18F26K80T-I/MM
PIC18F26K80T-I/MM023
PIC18F26K80T-I/MM025
PIC18F26K83-E/ML
PIC18F26K83-I/ML
PIC18F26K83T-I/ML
PIC18F27J13-I/ML
PIC18F27J13T-I/ML
PIC18F27J53-I/ML
PIC18F27J53T-I/ML
PIC18F27K42-E/ML
PIC18F27K42-I/ML
PIC18F27K42T-I/ML
PIC18F4220-E/ML
PIC18F4220-I/ML
PIC18F4220T-I/ML
PIC18F4221-E/ML
PIC18F4221-I/ML
PIC18F4320-E/ML
PIC18F4320-I/ML
PIC18F4320T-I/ML
PIC18F4321-E/ML
PIC18F4321-I/ML
PIC18F4331-I/ML
PIC18F43K20-E/ML
PIC18F43K20-I/ML
PIC18F43K20T-I/ML
PIC18F43K22-E/ML
PIC18F43K22-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F4410-I/ML
PIC18F4420-E/ML
PIC18F4420-I/ML
PIC18F4420T-I/ML
PIC18F4423-E/ML
PIC18F4423-I/ML
PIC18F4423T-I/ML
PIC18F442-I/ML
PIC18F4431-I/ML
PIC18F4450-I/ML
PIC18F4455-I/ML
PIC18F4458-I/ML
PIC18F4480-E/ML
PIC18F4480-I/ML
PIC18F4480T-I/ML
PIC18F44J10-I/ML
PIC18F44J11-I/ML
PIC18F44J11T-I/ML
PIC18F44J50-I/ML
PIC18F44J50T-I/ML
PIC18F44K20-E/ML
PIC18F44K20-I/ML
PIC18F44K20T-I/ML
PIC18F44K22-E/ML
PIC18F44K22-I/ML
PIC18F44K22T-I/ML
PIC18F4510-E/ML
PIC18F4510-I/ML
PIC18F4510T-I/ML
PIC18F4515-I/ML
PIC18F4520-E/ML
PIC18F4520-I/ML
PIC18F4520T-E/ML
PIC18F4520T-I/ML
PIC18F4523-E/ML
PIC18F4523-I/ML
PIC18F4523T-I/ML
PIC18F4525-E/ML
PIC18F4525-I/ML
PIC18F4525T-I/ML
PIC18F452-E/ML
PIC18F452-I/ML
PIC18F452T-I/ML
PIC18F4550-I/ML
PIC18F4553-I/ML
PIC18F4580-E/ML
PIC18F4580-I/ML
PIC18F4580T-I/ML
PIC18F4585-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F4585-I/ML

PIC18F4585T-I/ML

PIC18F45J10-I/ML

PIC18F45J10T-I/ML

PIC18F45J11-I/ML

PIC18F45J11T-I/ML

PIC18F45J50-I/ML

PIC18F45J50T-I/ML

PIC18F45K20-E/ML

PIC18F45K20-I/ML

PIC18F45K20-I/MLC01

PIC18F45K20-I/MLC05

PIC18F45K20T-I/ML

PIC18F45K20T-I/MLC01

PIC18F45K20T-I/MLC05

PIC18F45K22-E/ML

PIC18F45K22-I/ML

PIC18F45K22T-I/ML

PIC18F45K42-E/ML

PIC18F45K42-I/ML

PIC18F45K42T-I/ML

PIC18F45K80-E/ML

PIC18F45K80-H/ML

PIC18F45K80-I/ML

PIC18F45K80T-E/ML

PIC18F45K80T-I/ML

PIC18F4610-I/ML

PIC18F4620-E/ML

PIC18F4620-I/ML

PIC18F4620T-I/ML

PIC18F4680-E/ML

PIC18F4680-H/ML

PIC18F4680-I/ML

PIC18F4680T-I/ML

PIC18F4682-E/ML

PIC18F4682-I/ML

PIC18F4685-E/ML

PIC18F4685-I/ML

PIC18F4685T-I/ML

PIC18F46J11-I/ML

PIC18F46J11T-I/ML

PIC18F46J13-I/ML

PIC18F46J13T-I/ML

PIC18F46J50-I/ML

PIC18F46J50T-I/ML

PIC18F46J53-I/ML

PIC18F46J53T-I/ML

PIC18F46K20-E/ML

PIC18F46K20-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18F46K20T-I/ML

PIC18F46K22-E/ML

PIC18F46K22-I/ML

PIC18F46K22T-E/ML

PIC18F46K22T-I/ML

PIC18F46K42-E/ML

PIC18F46K42-I/ML

PIC18F46K42T-I/ML

PIC18F46K80-E/ML

PIC18F46K80-H/ML

PIC18F46K80-I/ML

PIC18F46K80T-E/ML

PIC18F46K80T-I/ML

PIC18F47J13-I/ML

PIC18F47J13T-I/ML

PIC18F47J53-I/ML

PIC18F47J53T-I/ML

PIC18F47K40-E/ML

PIC18F47K40-I/ML

PIC18F47K40T-E/ML

PIC18F47K40T-I/ML

PIC18F47K42-E/ML

PIC18F47K42-I/ML

PIC18F47K42T-I/ML

PIC18LF1220-I/ML

PIC18LF1230-I/ML

PIC18LF1320-I/ML

PIC18LF1320T-I/ML

PIC18LF1330-I/ML

PIC18LF13K22-E/ML

PIC18LF13K22-I/ML

PIC18LF13K22-I/ML023

PIC18LF13K22T-I/ML

PIC18LF13K22T-I/ML023

PIC18LF13K22T-I/ML024

PIC18LF13K50-I/MQ

PIC18LF13K50T-I/MQ

PIC18LF14K22-E/ML

PIC18LF14K22-I/ML

PIC18LF14K22T-E/ML

PIC18LF14K22T-E/ML021

PIC18LF14K22T-I/ML

PIC18LF14K50-I/MQ

PIC18LF14K50T-I/MQ

PIC18LF2221-I/ML

PIC18LF2321-I/ML

PIC18LF2321T-I/ML

PIC18LF2331-I/MM

PIC18LF2331T-I/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18LF23K22-I/ML

PIC18LF23K22T-I/ML

PIC18LF23K22T-I/ML020

PIC18LF23K22T-I/ML021

PIC18LF2410-I/ML

PIC18LF2410T-I/ML

PIC18LF2420-I/ML

PIC18LF2420T-I/ML

PIC18LF2420T-I/ML025

PIC18LF2423-I/ML

PIC18LF2423T-I/ML

PIC18LF2431-I/MM

PIC18LF2450-I/ML

PIC18LF2450T-I/ML206

PIC18LF2480-I/ML

PIC18LF2480T-I/ML

PIC18LF24J10-I/ML

PIC18LF24J11-I/ML

PIC18LF24J11T-I/ML

PIC18LF24J50-I/ML

PIC18LF24J50T-I/ML

PIC18LF24K22-E/ML

PIC18LF24K22-I/ML

PIC18LF24K22T-I/ML

PIC18LF24K42-E/ML

PIC18LF24K42-I/ML

PIC18LF24K42T-I/ML

PIC18LF24K50-E/ML

PIC18LF24K50-I/ML

PIC18LF24K50T-I/ML

PIC18LF2510-I/ML

PIC18LF2510T-I/ML

PIC18LF2520-I/ML

PIC18LF2520T-I/ML

PIC18LF2523-I/ML

PIC18LF2523T-I/ML

PIC18LF2580-I/ML

PIC18LF25J10-I/ML

PIC18LF25J10T-I/ML

PIC18LF25J11-I/ML

PIC18LF25J11T-I/ML

PIC18LF25J50-I/ML

PIC18LF25J50T-I/ML

PIC18LF25K22-E/ML

PIC18LF25K22-I/ML

PIC18LF25K22T-I/ML

PIC18LF25K42-E/ML

PIC18LF25K42-I/ML

PIC18LF25K42T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18LF25K50-I/ML
PIC18LF25K50T-I/ML
PIC18LF25K80-I/MM
PIC18LF25K80T-I/MM
PIC18LF25K83-E/ML
PIC18LF25K83-I/ML
PIC18LF25K83T-I/ML
PIC18LF26J11-I/ML
PIC18LF26J11T-I/ML
PIC18LF26J13-I/ML
PIC18LF26J13T-I/ML
PIC18LF26J50-I/ML
PIC18LF26J50T-I/ML
PIC18LF26J53-I/ML
PIC18LF26J53T-I/ML
PIC18LF26K22-E/ML
PIC18LF26K22-I/ML
PIC18LF26K22-I/MLC03
PIC18LF26K22-I/MLC04
PIC18LF26K22-I/MLC05
PIC18LF26K22-I/MLC06
PIC18LF26K22T-E/ML
PIC18LF26K22T-I/ML
PIC18LF26K22T-I/ML024
PIC18LF26K22T-I/MLC02
PIC18LF26K22T-I/MLC03
PIC18LF26K22T-I/MLC04
PIC18LF26K22T-I/MLC05
PIC18LF26K22T-I/MLC06
PIC18LF26K42-E/ML
PIC18LF26K42-I/ML
PIC18LF26K42T-I/ML
PIC18LF26K80-I/MM
PIC18LF26K80-I/MMC01
PIC18LF26K80T-I/MM
PIC18LF26K80T-I/MMC01
PIC18LF26K83-E/ML
PIC18LF26K83-I/ML
PIC18LF26K83T-I/ML
PIC18LF27J13-I/ML
PIC18LF27J13T-I/ML
PIC18LF27J53-I/ML
PIC18LF27J53T-I/ML
PIC18LF27K42-E/ML
PIC18LF27K42-I/ML
PIC18LF27K42T-I/ML
PIC18LF4220-I/ML
PIC18LF4220T-I/ML
PIC18LF4221-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC18LF4320-I/ML
PIC18LF4320T-I/ML
PIC18LF4320T-I/MLC06
PIC18LF4321-I/ML
PIC18LF4331-I/ML
PIC18LF43K22-E/ML
PIC18LF43K22-I/ML
PIC18LF43K22T-I/ML
PIC18LF4410-I/ML
PIC18LF4420-I/ML
PIC18LF4420T-I/ML
PIC18LF4423-I/ML
PIC18LF4423T-I/ML
PIC18LF442-I/ML
PIC18LF442T-I/ML
PIC18LF4431-I/ML
PIC18LF4450-I/ML
PIC18LF4450T-I/ML
PIC18LF4455-I/ML
PIC18LF4458-I/ML
PIC18LF4480-I/ML
PIC18LF4480T-I/ML
PIC18LF44J10-I/ML
PIC18LF44J11-I/ML
PIC18LF44J11T-I/ML
PIC18LF44J50-I/ML
PIC18LF44J50T-I/ML
PIC18LF44K22-E/ML
PIC18LF44K22-I/ML
PIC18LF44K22T-I/ML
PIC18LF4510-I/ML
PIC18LF4510T-I/ML
PIC18LF4515-I/ML
PIC18LF4520-I/ML
PIC18LF4520T-I/ML
PIC18LF4523-I/ML
PIC18LF4523T-I/ML
PIC18LF4525-I/ML
PIC18LF4525T-I/ML
PIC18LF452-I/ML
PIC18LF452T-I/ML
PIC18LF4539-I/ML
PIC18LF4550-I/ML
PIC18LF4553-I/ML
PIC18LF4580-I/ML
PIC18LF4585-I/ML
PIC18LF4585T-I/ML
PIC18LF45J10-I/ML
PIC18LF45J11-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC18LF45J50-I/ML

PIC18LF45J50T-I/ML

PIC18LF45K22-E/ML

PIC18LF45K22-I/ML

PIC18LF45K22T-I/ML

PIC18LF45K42-E/ML

PIC18LF45K42-I/ML

PIC18LF45K42T-I/ML

PIC18LF45K80-I/ML

PIC18LF45K80T-I/ML

PIC18LF4610-I/ML

PIC18LF4620-I/ML

PIC18LF4620-I/ML035

PIC18LF4620T-I/ML

PIC18LF4620T-I/ML035

PIC18LF4680-I/ML

PIC18LF4682-I/ML

PIC18LF4685-I/ML

PIC18LF4685T-I/ML

PIC18LF46J11-I/ML

PIC18LF46J11T-I/ML

PIC18LF46J13-I/ML

PIC18LF46J13T-I/ML

PIC18LF46J50-I/ML

PIC18LF46J50T-I/ML

PIC18LF46J53-I/ML

PIC18LF46J53T-I/ML

PIC18LF46K22-E/ML

PIC18LF46K22-I/ML

PIC18LF46K22T-I/ML

PIC18LF46K42-E/ML

PIC18LF46K42-I/ML

PIC18LF46K42T-I/ML

PIC18LF46K80-I/ML

PIC18LF46K80T-I/ML

PIC18LF47J13-I/ML

PIC18LF47J13T-I/ML

PIC18LF47J53-I/ML

PIC18LF47J53T-I/ML

PIC18LF47K40-E/ML

PIC18LF47K40-I/ML

PIC18LF47K40T-I/ML

PIC18LF47K42-E/ML

PIC18LF47K42-I/ML

PIC18LF47K42T-I/ML

PIC24EP128GP202-E/MM

PIC24EP128GP202-I/MM

PIC24EP128GP202-I/MM038

PIC24EP128GP202T-I/MM038

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC24EPT28GP204-H/ML
PIC24EP128GP204-I/ML
PIC24EP128GP204-I/MLA3
PIC24EP128GP204T-I/ML
PIC24EP128MC204-E/ML
PIC24EP128MC204-H/ML
PIC24EP128MC204-I/ML
PIC24EP128MC204-I/MLA3
PIC24EP128MC204T-I/ML
PIC24EP256GP202-E/MM
PIC24EP256GP202-H/MM
PIC24EP256GP202-I/MM
PIC24EP256GP202T-E/MM
PIC24EP256GP202T-H/MM
PIC24EP256GP202T-I/MM
PIC24EP256GP204-E/ML
PIC24EP256GP204-H/ML
PIC24EP256GP204-I/ML
PIC24EP256GP204T-E/ML
PIC24EP256GP204T-H/ML
PIC24EP256GP204T-I/ML
PIC24EP256GP204T-I/ML029
PIC24EP256MC202-E/MM
PIC24EP256MC202-H/MM
PIC24EP256MC202-I/MM
PIC24EP256MC202T-E/MM
PIC24EP256MC202T-H/MM
PIC24EP256MC202T-I/MM
PIC24EP256MC204-E/ML
PIC24EP256MC204-H/ML
PIC24EP256MC204-I/ML
PIC24EP256MC204T-E/ML
PIC24EP256MC204T-H/ML
PIC24EP256MC204T-I/ML
PIC24EP32GP202-E/MM
PIC24EP32GP202-I/MM
PIC24EP32GP202T-E/MM
PIC24EP32GP202T-I/MM
PIC24EP32GP204-E/ML
PIC24EP32GP204-H/ML
PIC24EP32GP204-I/ML
PIC24EP32GP204T-E/ML
PIC24EP32GP204T-H/ML
PIC24EP32GP204T-I/ML
PIC24EP32MC202-E/MM
PIC24EP32MC202-E/MM021
PIC24EP32MC202-I/MM
PIC24EP32MC202T-E/MM021
PIC24EP32MC204-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC24EP32MC204-I/ML
PIC24EP32MC204T-E/ML
PIC24EP32MC204T-H/ML
PIC24EP32MC204T-I/ML
PIC24EP512GP202-E/MM
PIC24EP512GP202-H/MM
PIC24EP512GP202-I/MM
PIC24EP512GP202T-H/MM
PIC24EP512GP204-E/ML
PIC24EP512GP204-H/ML
PIC24EP512GP204-I/ML
PIC24EP512GP204T-E/ML
PIC24EP512GP204T-H/ML
PIC24EP512GP204T-I/ML
PIC24EP512MC202-H/MM
PIC24EP512MC202-I/MM
PIC24EP512MC202T-H/MM
PIC24EP512MC204-E/ML
PIC24EP512MC204-H/ML
PIC24EP512MC204-I/ML
PIC24EP512MC204T-E/ML
PIC24EP512MC204T-H/ML
PIC24EP512MC204T-I/ML
PIC24EP64GP202-E/MM
PIC24EP64GP202-H/MM
PIC24EP64GP202-I/MM
PIC24EP64GP202T-H/MM
PIC24EP64GP202T-I/MM
PIC24EP64GP204-E/ML
PIC24EP64GP204-H/ML
PIC24EP64GP204-I/ML
PIC24EP64GP204-I/MLA3
PIC24EP64GP204T-E/ML
PIC24EP64GP204T-H/ML
PIC24EP64GP204T-I/ML
PIC24EP64MC202-E/MM
PIC24EP64MC202-H/MM
PIC24EP64MC202-I/MM
PIC24EP64MC202T-E/MM
PIC24EP64MC202T-H/MM
PIC24EP64MC202T-I/MM
PIC24EP64MC204-E/ML
PIC24EP64MC204-H/ML
PIC24EP64MC204-I/ML
PIC24EP64MC204T-E/ML
PIC24EP64MC204T-H/ML
PIC24EP64MC204T-I/ML
PIC24F04KA201-I/MQ
PIC24F04KL101-E/MQ

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC24F04KLT01T-I/MQ
PIC24F08KA101-E/MQ
PIC24F08KA101-I/MQ
PIC24F08KA101T-E/MQ
PIC24F08KA101T-I/MQ
PIC24F08KA101T-I/MQC02
PIC24F08KA102-E/ML
PIC24F08KA102-I/ML
PIC24F08KL201-E/MQ
PIC24F08KL201-I/MQ
PIC24F08KL201T-I/MQ
PIC24F08KL301-E/MQ
PIC24F08KL301-I/MQ
PIC24F08KL301T-I/MQ
PIC24F08KL301T-I/MQ020
PIC24F08KL302-E/ML
PIC24F08KL302-I/ML
PIC24F08KL302-I/MQ
PIC24F08KL302T-I/MQ
PIC24F08KL401-E/MQ
PIC24F08KL401-I/MQ
PIC24F08KL402-I/ML
PIC24F08KL402-I/MQ
PIC24F08KM202-I/ML
PIC24F16KA101-E/MQ
PIC24F16KA101-I/MQ
PIC24F16KA101T-E/MQ
PIC24F16KA101T-I/MQ
PIC24F16KA102-E/ML
PIC24F16KA102-I/ML
PIC24F16KA102T-I/ML
PIC24F16KA302-I/ML
PIC24F16KA302T-I/ML
PIC24F16KA304-I/ML
PIC24F16KA304T-I/ML
PIC24F16KL401-E/MQ
PIC24F16KL401-I/MQ
PIC24F16KL401T-I/MQ
PIC24F16KL402-E/MQ
PIC24F16KL402-I/ML
PIC24F16KL402-I/MQ
PIC24F16KL402T-I/ML
PIC24F16KL402T-I/MQ
PIC24F16KM102-I/ML
PIC24F16KM202-E/ML
PIC24F16KM202-I/ML
PIC24F16KM204-E/ML
PIC24F16KM204-I/ML
PIC24F32KA302-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC24F32KA302T-E/ML

PIC24F32KA302T-I/ML

PIC24F32KA304-E/ML

PIC24F32KA304-I/ML

PIC24F32KA304T-I/ML

PIC24FJ128GA202-E/MM

PIC24FJ128GA202-I/MM

PIC24FJ128GA202T-I/MM

PIC24FJ128GA204-I/ML

PIC24FJ128GA204T-I/ML

PIC24FJ128GA702-I/ML

PIC24FJ128GA702T-I/ML

PIC24FJ128GB202-I/MM

PIC24FJ128GB202T-I/MM

PIC24FJ128GB204-E/ML

PIC24FJ128GB204-I/ML

PIC24FJ128GB204T-I/ML

PIC24FJ16GA002-E/ML

PIC24FJ16GA002-I/ML

PIC24FJ16GA002-I/MLB4

PIC24FJ16GA002-I/MLC10

PIC24FJ16GA002T-E/ML

PIC24FJ16GA002T-I/ML

PIC24FJ16GA002T-I/ML023

PIC24FJ16GA002T-I/MLC05

PIC24FJ16GA002T-I/MLC06

PIC24FJ16GA004-E/ML

PIC24FJ16GA004-I/ML

PIC24FJ16GA004T-I/ML

PIC24FJ16GA004T-I/MLC09

PIC24FJ16MC102-E/ML

PIC24FJ16MC102-H/ML

PIC24FJ16MC102-I/ML

PIC24FJ16MC102T-E/ML

PIC24FJ16MC102T-I/ML

PIC24FJ256GA702-I/ML

PIC24FJ256GA702T-I/ML

PIC24FJ32GA002-E/ML

PIC24FJ32GA002-I/ML

PIC24FJ32GA002T-E/ML

PIC24FJ32GA002T-I/ML

PIC24FJ32GA002T-I/ML030

PIC24FJ32GA002T-I/ML031

PIC24FJ32GA002T-I/MLC06

PIC24FJ32GA002T-I/MLC11

PIC24FJ32GA004-E/ML

PIC24FJ32GA004-I/ML

PIC24FJ32GA004T-E/ML

PIC24FJ32GA004T-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC24FJ32GAT02-E/ML
PIC24FJ32GA102-I/ML
PIC24FJ32GA102T-I/ML
PIC24FJ32GA104-E/ML
PIC24FJ32GA104-I/ML
PIC24FJ32GA104-I/ML021
PIC24FJ32GA104-I/ML023
PIC24FJ32GA104-I/ML025
PIC24FJ32GA104T-E/ML
PIC24FJ32GA104T-I/ML
PIC24FJ32GA104T-I/ML021
PIC24FJ32GA104T-I/ML023
PIC24FJ32GA104T-I/ML024
PIC24FJ32GA104T-I/ML025
PIC24FJ32GB002-I/ML
PIC24FJ32GB002T-I/ML
PIC24FJ32GB002T-I/MLC01
PIC24FJ32GB004-I/ML
PIC24FJ32GB004T-I/ML
PIC24FJ32MC102-E/ML
PIC24FJ32MC102-I/ML
PIC24FJ32MC102T-I/ML
PIC24FJ32MC104-I/ML
PIC24FJ48GA002-I/ML
PIC24FJ48GA002-I/MLB
PIC24FJ48GA002T-I/ML
PIC24FJ48GA002T-I/MLB
PIC24FJ48GA004-E/ML
PIC24FJ48GA004-I/ML
PIC24FJ48GA004T-I/ML
PIC24FJ48GA004T-I/ML022
PIC24FJ64GA002-E/ML
PIC24FJ64GA002-I/ML
PIC24FJ64GA002-I/ML022
PIC24FJ64GA002T-E/ML
PIC24FJ64GA002T-I/ML
PIC24FJ64GA002T-I/ML022
PIC24FJ64GA002T-I/MLC03
PIC24FJ64GA004-E/ML
PIC24FJ64GA004-I/ML
PIC24FJ64GA004-I/MLB4
PIC24FJ64GA004-I/MLC13
PIC24FJ64GA004T-I/ML
PIC24FJ64GA004T-I/MLC13
PIC24FJ64GA102-I/ML
PIC24FJ64GA102T-I/ML
PIC24FJ64GA104-E/ML
PIC24FJ64GA104-I/ML
PIC24FJ64GA104T-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC24FJ64GA202-E/MM

PIC24FJ64GA202-I/MM

PIC24FJ64GA202T-I/MM

PIC24FJ64GA204-E/ML

PIC24FJ64GA204-I/ML

PIC24FJ64GA204T-I/ML

PIC24FJ64GA702-I/ML

PIC24FJ64GA702T-I/ML

PIC24FJ64GB002-I/ML

PIC24FJ64GB002T-I/ML

PIC24FJ64GB004-I/ML

PIC24FJ64GB004T-I/ML

PIC24FJ64GB202-E/MM

PIC24FJ64GB202-I/MM

PIC24FJ64GB202T-I/MM

PIC24FJ64GB204-E/ML

PIC24FJ64GB204-I/ML

PIC24FV08KM202-I/ML

PIC24FV16KA302-I/ML

PIC24FV16KA302T-I/ML

PIC24FV16KA304-I/ML

PIC24FV16KA304T-I/ML

PIC24FV16KM102-I/ML

PIC24FV16KM202-E/ML

PIC24FV16KM202-I/ML

PIC24FV16KM202T-I/ML

PIC24FV16KM204-I/ML

PIC24FV32KA302-I/ML

PIC24FV32KA302T-I/ML

PIC24FV32KA304-E/ML

PIC24FV32KA304-I/ML

PIC24FV32KA304T-I/ML

PIC24HJ128GP202-E/MM

PIC24HJ128GP202-I/MM

PIC24HJ128GP202T-E/MM

PIC24HJ128GP202T-I/MM

PIC24HJ128GP204-E/ML

PIC24HJ128GP204-I/ML

PIC24HJ128GP204T-E/ML

PIC24HJ128GP204T-I/ML

PIC24HJ128GP502-E/MM

PIC24HJ128GP502-H/MM

PIC24HJ128GP502-I/MM

PIC24HJ128GP502T-E/MM

PIC24HJ128GP502T-H/MM

PIC24HJ128GP502T-I/MM

PIC24HJ128GP504-E/ML

PIC24HJ128GP504-H/ML

PIC24HJ128GP504-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC24HJ128GP504T-H/ML

PIC24HJ128GP504T-I/ML

PIC24HJ12GP202-E/ML

PIC24HJ12GP202-I/ML

PIC24HJ16GP304-H/ML

PIC24HJ16GP304-I/ML

PIC24HJ16GP304T-E/ML

PIC24HJ16GP304T-I/ML

PIC24HJ32GP202-E/MM

PIC24HJ32GP202-H/MM

PIC24HJ32GP202-I/MM

PIC24HJ32GP202T-I/MM

PIC24HJ32GP204-E/ML

PIC24HJ32GP204-I/ML

PIC24HJ32GP204T-E/ML

PIC24HJ32GP204T-I/ML

PIC24HJ32GP302-E/MM

PIC24HJ32GP302-I/MM

PIC24HJ32GP302T-E/MM

PIC24HJ32GP302T-I/MM

PIC24HJ32GP304-E/ML

PIC24HJ32GP304-I/ML

PIC24HJ32GP304T-E/ML

PIC24HJ32GP304T-I/ML

PIC24HJ64GP202-E/MM

PIC24HJ64GP202-I/MM

PIC24HJ64GP202T-E/MM

PIC24HJ64GP202T-I/MM

PIC24HJ64GP204-E/ML

PIC24HJ64GP204-I/ML

PIC24HJ64GP204T-E/ML

PIC24HJ64GP204T-I/ML

PIC24HJ64GP502-E/MM

PIC24HJ64GP502-H/MM

PIC24HJ64GP502-I/MM

PIC24HJ64GP502T-E/MM

PIC24HJ64GP502T-H/MM

PIC24HJ64GP502T-I/MM

PIC24HJ64GP504-E/ML

PIC24HJ64GP504-I/ML

PIC24HJ64GP504T-E/ML

PIC24HJ64GP504T-I/ML

PIC32MM0016GPL028-E/ML

PIC32MM0016GPL028-I/ML

PIC32MM0016GPL028T-I/ML

PIC32MM0032GPL028-E/ML

PIC32MM0032GPL028-I/ML

PIC32MM0032GPL028T-I/ML

PIC32MM0064GPL028-E/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard, 120K, 130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L, 16L and 28L QFN packages.

PIC32MM0064GPL028T-I/ML
PIC32MM0064GPM028-I/ML
PIC32MM0064GPM028T-I/ML
PIC32MM0128GPM028-I/ML
PIC32MM0128GPM028T-I/ML
PIC32MM0256GPM028-I/ML
PIC32MM0256GPM028T-I/ML
PIC32MX110F016B-I/ML
PIC32MX110F016BT-I/ML
PIC32MX110F016BT-V/ML
PIC32MX110F016B-V/ML
PIC32MX110F016D-I/ML
PIC32MX110F016DT-I/ML
PIC32MX110F016DT-V/ML
PIC32MX110F016D-V/ML
PIC32MX120F032B-50I/ML
PIC32MX120F032B-I/ML
PIC32MX120F032BT-50I/ML
PIC32MX120F032BT-I/ML
PIC32MX120F032BT-V/ML
PIC32MX120F032B-V/ML
PIC32MX120F032D-50I/ML
PIC32MX120F032D-I/ML
PIC32MX120F032DT-50I/ML
PIC32MX120F032DT-I/ML
PIC32MX120F032DT-V/ML
PIC32MX120F032D-V/ML
PIC32MX130F064B-I/ML
PIC32MX130F064BT-I/ML
PIC32MX130F064BT-V/ML
PIC32MX130F064B-V/ML
PIC32MX130F064D-I/ML
PIC32MX130F064DT-I/ML
PIC32MX130F064DT-V/ML
PIC32MX130F064D-V/ML
PIC32MX150F128B-50I/ML
PIC32MX150F128B-I/ML
PIC32MX150F128BT-50I/ML
PIC32MX150F128BT-I/ML
PIC32MX150F128BT-V/ML
PIC32MX150F128B-V/ML
PIC32MX150F128D-50I/ML
PIC32MX150F128D-I/ML
PIC32MX150F128DT-50I/ML
PIC32MX150F128DT-I/ML
PIC32MX150F128DT-V/ML
PIC32MX150F128D-V/ML
PIC32MX154F128B-I/MM
PIC32MX154F128BT-I/MM

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC32MX154F128B-V/MM
PIC32MX154F128D-I/ML
PIC32MX154F128DT-I/ML
PIC32MX154F128DT-V/ML
PIC32MX154F128D-V/ML
PIC32MX170F256D-50I/ML
PIC32MX170F256D-I/ML
PIC32MX170F256DT-50I/ML
PIC32MX170F256DT-I/ML
PIC32MX170F256DT-V/ML
PIC32MX170F256D-V/ML
PIC32MX174F256B-I/MM
PIC32MX174F256BT-I/MM
PIC32MX174F256BT-V/MM
PIC32MX174F256B-V/MM
PIC32MX174F256D-I/ML
PIC32MX174F256DT-I/ML
PIC32MX174F256DT-V/ML
PIC32MX174F256D-V/ML
PIC32MX210F016B-I/ML
PIC32MX210F016BT-I/ML
PIC32MX210F016BT-V/ML
PIC32MX210F016B-V/ML
PIC32MX210F016D-I/ML
PIC32MX210F016DT-I/ML
PIC32MX210F016DT-V/ML
PIC32MX210F016D-V/ML
PIC32MX220F032B-50I/ML
PIC32MX220F032B-I/ML
PIC32MX220F032BT-50I/ML
PIC32MX220F032BT-I/ML
PIC32MX220F032BT-V/ML
PIC32MX220F032B-V/ML
PIC32MX220F032D-50I/ML
PIC32MX220F032D-I/ML
PIC32MX220F032DT-50I/ML
PIC32MX220F032DT-I/ML
PIC32MX220F032DT-V/ML
PIC32MX220F032D-V/ML
PIC32MX230F064B-I/ML
PIC32MX230F064BT-I/ML
PIC32MX230F064BT-V/ML
PIC32MX230F064B-V/ML
PIC32MX230F064D-I/ML
PIC32MX230F064DT-I/ML
PIC32MX230F064DT-V/ML
PIC32MX230F064D-V/ML
PIC32MX250F128B-50I/ML
PIC32MX250F128B-I/ML

LIAL-21URFI599 - CCB 3223, 3223.001-3223.007 Final Notice: Qualification of MMT as an additional assembly site for selected products of 0.25um, 0.18um TSMC, 70nm SMIC, Vanguard,120K,130K, 150K, 160K, 165K, 200K and 290K wafer technologies in 44L, 28 QFN-S, 20L,16L and 28L QFN packages.

PIC32MX250F128BT-I/ML
PIC32MX250F128BT-I/ML028
PIC32MX250F128BT-V/ML
PIC32MX250F128B-V/ML
PIC32MX250F128D-50I/ML
PIC32MX250F128D-I/ML
PIC32MX250F128DT-50I/ML
PIC32MX250F128DT-I/ML
PIC32MX250F128DT-I/ML026
PIC32MX250F128DT-V/ML
PIC32MX250F128D-V/ML
PIC32MX254F128B-I/MM
PIC32MX254F128BT-I/MM
PIC32MX254F128BT-V/MM
PIC32MX254F128B-V/MM
PIC32MX254F128D-I/ML
PIC32MX254F128DT-I/ML
PIC32MX254F128DT-V/ML
PIC32MX254F128D-V/ML
PIC32MX270F256D-50I/ML
PIC32MX270F256D-I/ML
PIC32MX270F256DT-50I/ML
PIC32MX270F256DT-I/ML
PIC32MX270F256DT-V/ML
PIC32MX270F256D-V/ML
PIC32MX274F256B-I/MM
PIC32MX274F256BT-I/MM
PIC32MX274F256BT-V/MM
PIC32MX274F256B-V/MM
PIC32MX274F256D-I/ML
PIC32MX274F256DT-I/ML
PIC32MX274F256DT-V/ML
PIC32MX274F256D-V/ML
SSC7150-ML-AB0
SSC7150-ML-AB0-TR
SSC7150-ML-AB1
SSC7150-ML-AB1-TR
UTC2000/MG
UTC2000-E/MG
UTC2000-I/MG
UTC2000T/MG
UTC2000T-E/MG
UTC2000T-I/MG